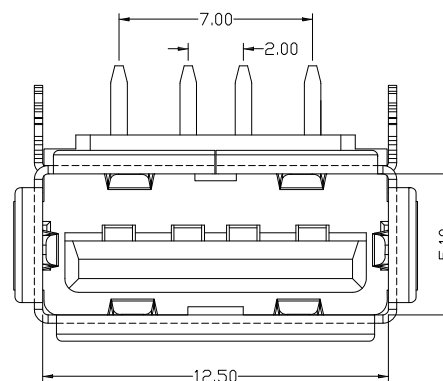
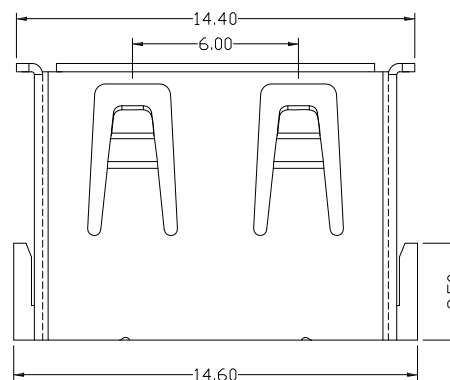
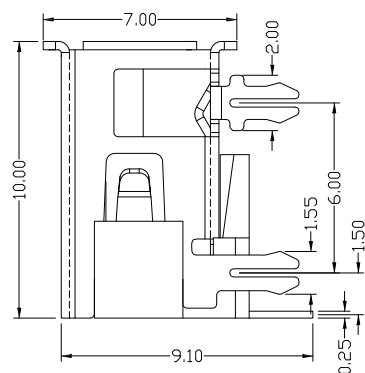
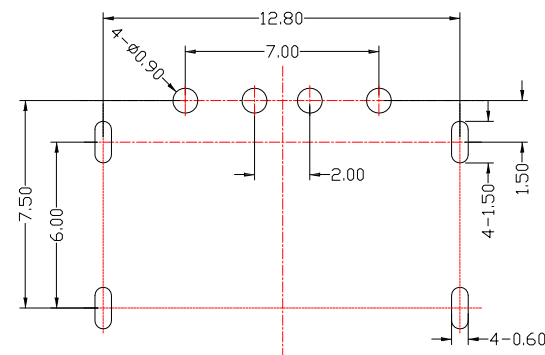
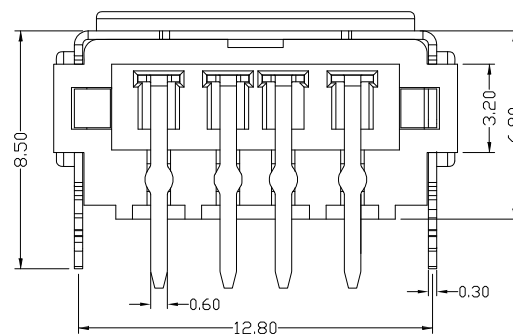


White : W



- 1.Contact: Plated Gold in Mating Area ;
Tin Plated on Solder Balls
Nickel under plated overall
- 2.Shell: Nickel under Plated surface layer

				建倚科技股份有限公司 CONTACT TECHNOLOGY CORP. TOLERANCE UNLESS OTHERWISE STATED : Up to 5 ±0.2 Above 5 ~ 15 ±0.3 Above 15 ~ 30 ±0.4 Above 30 ~ 50 ±0.5 Angle ±0.3° 3RD. ANGEL'S  UNITS MM	DRAWN BY: DATE		MAT'L	TITLE	CONNECTOR					
					Jack Lu	10/21/13								
					CHECKED BY: DATE		FINISH		MODLE	USB AF 10.0插板四腳有卷邊 =6.8				
2	更新Operating Temperature	102113	Jack		Jacky Chen	10/21/13	SCALE	1 : 1	DWG NO.	SUA-110H4-x-S235	SIZE			
1	更新SPEC和PCB尺寸更新及新增尺寸	090513	Jack				APPROVED BY: DATE	T	Tony Kao	10/21/13	SHEET NO.	1 of 1	PART NO.	SUA-110H4-x-S235
ITEM NO.	DESCRIPTION	DRAWN	DATE	VER										
	A		B	C	D	E	F	G	H	I	J	K	L	M